

Material Data Sheet

Inductor

Product Class	SMD Inductor B82464E6xxxxxxx	
Date	20.08.2021	
IMDS ID if available		
Version	01	

Product Part (IMDS: semi component)	Material Class (IMDS: Material)	Material (Classification) VDA 231	Substance	TMPS**) [wt%]	CAS if applicable	typical mass of material [wt-%]	Traces see 1)
Active Part	Ceramic	1C	Ferrite Ni-Zn	100	12645-50-0	65	
Heavy Metal		1C	Cu	100	7440-50-8	23.7	
	Elastomer 2B Polyurethane (PUR)		100	9009-54-5	1.3		
Encapsulation	Thermoplastic	2A	Polyphenylene sulfide (PPS)	35	26125-40-6	5.4	
			Glass fiber	65	65997-17-3	5.4	
	Organic, solid	5B	Quartz	30-50	14808-60-7		
			Dimethylvinylated and trimethylated silica	15-35	68988-89-6	3.5	
			Dimethyl siloxane, dimethylvinyl-terminated	40-60	68083-19-2		
	Organic, solid	5B	Dimethylhydropolysiloxane	63	68037-59-2	0.5	
	Organic, solid		Quartz	37	14808-60-7	-60-7	
Termination	Hoover Motol	/ Metal 1C	Cu	94	7440-50-8	7440-50-8 0.5	
	Heavy Metal		Sn	6	7440-31-5	0.5	
	Heavy Metal	1C	Cu	100	7440-50-8		х
	Heavy Metal	1C	Sn	100	7440-31-5	0.1	
	Sum in total:					100	

					100	
Sizes	weight range	part numbers	Sizes	weight range	part numbers	
[max. in mm]	[approx. in g]		[max. in mm]	[approx. in g]		
10.4x10.4x6.3	2.0	B82472E6254M000				

Not Part of	Not Part of a Product Class					
Contact	ontact Dr. Johann Reindl, MAG EPQM		Important remarks:			
Division	TDK Electronics AG, Magnetics Business Group (MAG) Rosenheimer Strasse 116b, 81669 Munich			The declaration limit is 0.1% as defined by IEC 62474 (IEC PAS 61906). Traces are		
Address				product parts, substances etc. that are below a percentage of 0.1 % by weight, if not otherwise regulated.		
	Tel: +49 89 54020 3030	mailto:	2)	This Material Data Sheet contains typical values of the respective products set forth		
		johann.reindl@tdk-electronics.tdk.com		herein. We expressly point out that all values and statements contained herein are		
*) others: .(not declarable or prohibited substances acc. GADSL) **) typical mass percentage of substance				based on our best present knowledge and cannot be regarded as binding statements or binding product specifications, unless otherwise explicitly agreed in writing. TDK		
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				HEREIN, INCLUDING BUT NOT LIMITED TO ANY REPRESENTATION OR		
				WARRANTY OF MERCHANTABILITY OR SUITABILITY FOR ANY PURPOSE.		

The products set forth herein are "RoHS-compatible". RoHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

RoHS - Exemptions for the Product Class / Product according to Annex III: (🗹 valid 🗆 not valid)

☑ no exemptions;

Exemption 6 (a): Lead as an alloying element in steel for machining purposes and in galvanized steel containing up to 0,35 % lead by weight;

Exemption 6 (b): Lead as an alloying element in aluminium containing up to 0,4 % lead by weight;

Exemption 6 (c): Copper alloy containing up to 4 % lead by weight;

Exemption 7 (a): Lead in high melting temperature type solder (i.e. lead-based alloys containing 85 % by weight or more lead);

Exemption 7 (c)-I: Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g. piezoelectronic devices, or in a glass or ceramic matrix compound;

Exemption 7 (c)-II: Lead in dielectric ceramic in capacitors for a rated voltage of 125 V AC or 250 V DC or higher;

Exemption 7 (c)-III: Lead in dielectric ceramic in capacitors for a rated voltage of less than 125 V AC or 250 V DC;

Exemption 15: Lead in solders to complete a viable electrical connection between semiconductor die and carrier within integrated circuit Flip Chip packages;

Other Exemption than above

Umbrella Specification Rev 5.02.1a, based on ZVEI Layout, TDK Electronics AG, Dept. TQ, 03/2019

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